



Dear Valued Customer

Issue date:

Youichi Kajiwara
Group General Manager

Digital Control LSI Segment
LSI Development HQ.
ROHM Co., Ltd.

Notification of Product/Process Change

Doc. No.: 1626007

(TG131)

This letter intends as a formal notification of change to products which are currently supplied by ROHM Co., Ltd.

ROHM Co., Ltd. requires customers to provide acknowledgment of the receipt of this notification within 30 days from the date of this notice. Lack of acknowledgment of this notice within 30 days is considered as acceptance of the change.

After acknowledgement of the customer, lack of additional response within 90 day period constitutes acceptance of the change according to JEDEC Standard J-STD-046.

Your understanding and cooperation would be highly appreciated.

Issue Date: September 1, 2026

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Title of change	Lapis LSI bonding wire material change from gold to copper September 2026	
Affected product(s)	Manufacturer part number	Customer part number
	Refer to list	Refer to list
Detailed description of change	Before	After
	Gold Wire	Copper Wire
Reason for change	With the surge in gold material prices, the price of gold wire has increased, making it difficult to maintain product prices. We are requesting customers to switch to copper wire to curb price increases caused by the increase in gold wire prices.	
Anticipated impact on quality	There is no impact on product quality. In addition, copper wire has already been adopted for mass production in many products and has a proven track record in mass production.	
Identification of change	It can be identified by internal part number on product label.	
Planned first ship date	October 1, 2027	Sample available schedule : Sep,1,2026
Comments		
Supplier contact	Please contact the local ROHM sales office or the authorized distributor.	
Notes		